MR2863-374

Form PTO-1595 (Rev. 09/04) OMB No. 0651-0027.(exp. 6/30/2005)	U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office	
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YEN-WEI CHEN	Name: MITAC TECHNOLOGY CORP.	
Everyties Data/a) p/s/2007	Street Address: 4TH FLOOR, NO. 1, R&D 2ND ROAD,	
Execution Date(s) 9/1/2007 Additional name(s) of conveying party(ies) attached? Yes No	HSIN-CHU SCIENCE BASED INDUSTRIAL PARK	
3. Nature of conveyance:		
Assignment Merger	City: <u>HSIN-CHU HSIEN</u>	
Security Agreement Change of Name	State:	
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Executive Order 9424, Confirmatory License	Country: TAIWAN, R.O.C. Zip:	
Other	Additional name(s) & address(es) attached? 🔲 Yes 🗹 No	
	document is being filed together with a new application.	
A. Patent Application No.(s)	B. Patent No.(s)	
12/232,191		
	pochod? Type I/No	
Additional numbers attached? Yes VNo 5. Name and address to whom correspondence 6. Total number of applications and patents		
concerning document should be mailed:	Involved: 1	
Name: Morton J. Rosenberg, Esg.	7. Total fee (37 CFR 1.21(h) & 3.41) \$_40.00	
Internal Address: Rosenberg, Klein & Lee	Authorized to be charged by credit card	
	Authorized to be charged to deposit account	
Street Address: 3458 Ellicott Center Drive,	Enclosed	
Suite 101	None required (government interest not affecting title)	
City: Ellicott City	8. Payment Information	
State: MD Zip: 21043	a. Credit Card Last 4 Numbers Expiration Date	
Phone Number: 410-465-6678	b. Deposit Account Number 18-2011	
Fax Number: 410-461-3067	Authorized User Name	
Email Address: rkl@rklpatlaw.com		
9. Signature:	9/25/2008	
Signature	Date Total number of pages including cover 2	
Morton J. Rosenberg Name of Person Signing	sheet, attachments, and documents:	

Documents to be recorded (Including cover sheet) should be faxed to (703) 306-5995, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

PATENT REEL: 021591 FRAME: 0597

P.02

Docket No.: MR2863-374

ASSIGNMENT

INVENTOR(S): Yen-Wei Chen

RECORDED: 09/25/2008

In consideration of the sum of one U.S. dollar (US\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned agree to assign, and hereby does assign, transfer and set over to Mitac Technology Corp. of Taiwan, R.O.C., having an address of 4th Floor, No. 1, R&D 2nd Road, Hsin-Chu Science Based Industrial Park, Hsin-Chu Hsien, Taiwan, R.O.C. (hereinafter designated the "Assignee") the entire right, title and interest in the invention known as Adaptor Device for Connecting and Accessing Data Card and Computer Device Incorporating the Adaptor Device, for which the undersigned have executed an application for patent in the United States of America. Serial No. 12/232,191, filed 9/12/2008

The undersigned agree to execute all papers necessary in connection with the application and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the international Convention for Protection of Industrial Property or similar agreements.

The undersigned agree to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize and request the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or continuing applications thereof to Assignee, as Assignee of the entire interest, and hereby covenant that they have full right to convey the entire interest herein assigned, and that they have not executed and will not execute any agreement in conflict herewith.

Name	Yen-Wei Chen (Family Name: Chen)	
Address	No. 1, R&D 2nd Road, Hsin-Chu Science Based Industrial Park, Hsin-Chu Hsien, Taiwan, R.O.C.	
Signature	YEN-WEI CHEN	
Date	2007.9.1	

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